



## **LiloTree Launch Award-winning Ni-less ENIG-Premium Plating Services For HDI, High Frequency, RF, Microwave PCBs/Semiconductors**

**Redmond, WA. June 29, 2020**

LiloTree's award-winning Ni-less ENIG-Premium is an ideal solution for HDI, High frequency, RF, Microwave PCBs/semiconductors applications. Ni-Less ENIG-Premium was initiated when LiloTree sought to find high reliable solution to insertion/electromagnetic loss caused by presence of Ni in ENIG, ENEPIG, etc.

"Development of Ni-Less ENIG-Premium sprouted from actual customer pain points," said Kunal Shah, President at LiloTree. "More than 50 PCB manufacturers and OEMs with whom we consulted indicated that they had faced ENIG related issues in the past, and the demand for the solution is very high." The response has been positive, and several of the leading OEM/PCB manufacturers are currently using Ni-Less ENIG-Premium™ and realizing the benefits of improved reliability of electronic assemblies.

LiloTree now offers Ni-less ENIG-Premium plating services. Customized plating options are available with quick turnaround options, high tech capability and superior quality. Plating options include Au wire bondable surface, standard solderable surface, contacts/wear surface, specific Au thickness requirements, etc.

### **For more information:**

<http://www.lilotree.com/news/platingservice>

<http://www.lilotree.com>

<http://www.lilotree.com/news/introducing-ni-less-enig-premium>

<http://www.lilotree.com/contact>

### **About LiloTree**

LiloTree develops, manufactures, and distributes advanced engineered materials including Ni-less ENIGPremium™ and other product improvement solutions for industries such as aviation & aerospace, medical electronics, semiconductor, naval electronics, consumer electronics, etc.

Headquartered in Redmond, Washington, LiloTree offers materials and solutions worldwide.